



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Mark R. Prausnitz, Mark G. Allen, and Inder-Jeet Gujral

Serial No.:

09/453,109

Art Unit:

Filed:

December 2, 1999

Examiner:

Not Yet Assigned

For:

MICRONEEDLE DEVICE FOR EXTRACTION AND SENSING OF BODILY

FLUIDS

Assistant Commissioner for Patents Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Sir:

Pursuant to 37 C.F.R. §1.56 and 37 C.F.R. §1.97, Applicants submit an Information Disclosure Statement, including seven (7) pages of Form PTO-1449 and a copy of each document cited therein.

This Information Disclosure Statement is being filed under 37 C.F.R. § 1.97(b) prior to a first Office Action on the merits. It therefore is believed that no fee is required with this submission. However, should a fee be required, the Commissioner is hereby authorized to charge any required fees to Deposit Account No. 01-2507. A duplicate of this transmittal is enclosed to facilitate the process.

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Remarks

This statement should not be interpreted as a representation that an exhaustive search has been conducted or that no better art exists. Moreover, Applicants invite the Examiner to make an independent evaluation of the cited art to determine its relevance to the subject matter of the present application. Applicants are of the opinion that their claims patentably distinguish over the art referred to herein, either alone or in combination.

Respectfully submitted,

Kevin W. King

Reg. No. 42,737

Dated: January 19, 2000

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INFORMATION DISCLOSURE STATEMENT

Certificate of Mailing under 37 C.F.R. § 1.8(a)

I hereby certify that this Information Disclosure Statement, along with any paper referred to as being attached or enclosed, is being deposited with the United States Postal Service on the date shown below with sufficient postage as first-class mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

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Julie A. Tennyson

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT	A True was
(use as many sheets as necessary)	Filing Date First Named Inventor December 2, 1999 Mark R. Prausnitz
	Group Art Unit
7	Attorney Docket Number GTRC 2133

		Attorney L	JUCKET IVE	
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				First Named Inventor	Mark R. Prausnitz
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¹ Unique citation designation number ² See attached Kinds of U.S. Patent Documents. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant to place a check mark here if English language Translation is attached.

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¹ Unique citation designation number ² See attached Kinds of U.S. Patent Documents. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant to place a check mark here if English language Translation is attached.

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Initials*	No.1	item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	
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				First Named Inventor	Mark R. Prau	snitz
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l				First Named Inventor	Mark R. Prausnitz
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